

Preliminary Amendment

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Title: ELECTRONIC COMPONENT AND PANEL AND METHOD FOR THE PRODUCTION THEREOF

IN THE ABSTRACT

Please replace the Abstract with the following rewritten paragraph:

Abstract

**ELECTRONIC COMPONENT AND PANEL AND METHOD FOR
PRODUCING THE SAME**

Abstract

The invention relates to an electronic component and a panel-(36), the electronic component having a semiconductor chip (2)-with a wiring board (3)-and a plastic package-(4). The plastic package (4)-is made up of two layers (5,6)-of plastic package molding compound (23)-arranged one on top of the other. These layers are created with the aid of a printing operation under normal atmosphere.

{Figure 1}